SWISSDIS



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SPECIFICATIONS

US0603YG LED Chip 0603 Yellow Green

Version December 2015

email: info@unilite-tech.com

U-S0603YG

Description

The SMD type U-S0603YG, Yellow Green LED, with its light weight and smaller than lead frame type components, enables smaller board size, higher packing density, reduced storage space and miniature applications.



Dice Material : AlInGaPLight Color : Yellow GreenLens Color : Water Clear

Features

- 1 chips package
- · Compatible with automatic placement equipment
- · Compatible with reflow soldering process
- · Long operating life
- · Low forward voltage operated
- · Instant light
- · Pb -free/ RoHS compliant

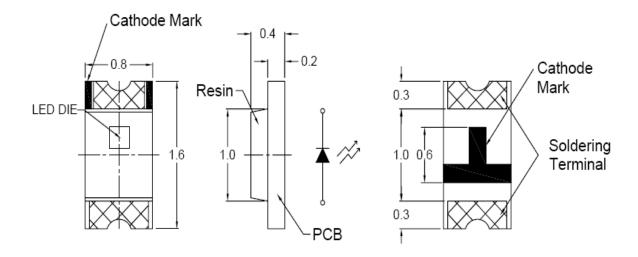
Applications

- · Information boards
- · Automotive Interior Lighting
- · Indoor and outdoor display
- Indicator
- Backlighting
- · Gerneral applications

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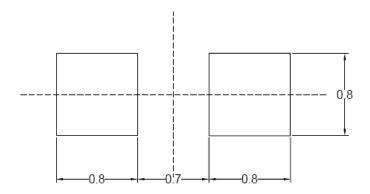
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■ Outline Dimensions (mm)

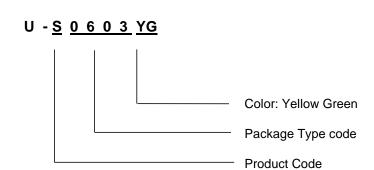


Tolerance: ± 0.1 mm

■ Recommended Soldering Pad Design



■ Part Numbering System



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■ Absolute Maximum Ratings at Ta = 25 $^{\circ}$ C

PARAMETER	symbo	MAX.	UNIT
Power Dissipation *	PD	78	mW
Continuous Forward Current *	lF	30	mA
Peak Forward Current (1/10 Duty Cycle , 0.1ms Pulse Width) *	IFP	90	mA
Reverse Voltage	IR	10	μ A
Electrostatic Discharge	ESD	2000	V
Operating Temperature Range	Topr	-40 to $+85$	°C
Storage Temperature Range	Tstg	-40 to $+90$	°C
Reflow Soldering Condition	Tsld	260 °C for 10 sec. 2 °	time.

■ Electro-Optical Characteristics

Yellow Green ,T_a = 25°C, IF=20mA

PARAMETER	SYMBOL	VALUES			UNIT
FARAIVIETER		MIN.	TYP.	MAX.	UNIT
Luminous Intensity	IV	32	50	125	mcd
Forward Voltage	Vf	1.5		2.4	V
View angle	20 1/2		110		Deg
Dominant Wavelength	λd	566	575	576	nm
Reverse Current, VR= 5V	I _R			10	μΑ

■ Bin Code of IV

Unit: mcd@20mA

Bin Code		IV		
		Min	Max	
Yellow Green	YG1	32	50	
	YG2	50	80	
	YG3	80	125	

■ Bin Code of Wavelength

Unit: mcd@20mA

Bin Code		IV		
		Min	Max	
Yellow Green	YGW1	566	568	
	YGW2	568	570	
	YGW3	570	572	
	YGW4	572	574	
	YGW5	574	576	

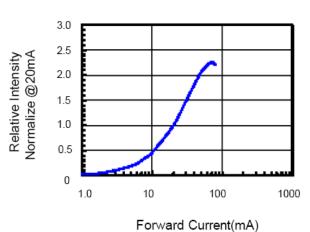
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Typical Electro-Optical Characeristics Curve--Yellow Green



1000 Forward Current(mA) 100 10 1.0 0.1 1.0 2.0 3.0 4.0 5.0 Forward Voltage(V)

Fig.2 Relative Intensity vs. Forward Current





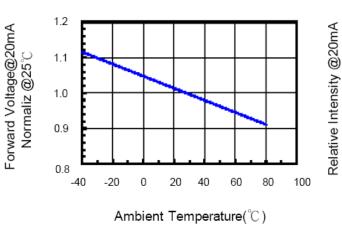


Fig.4 Relative Intensity vs. Temperature

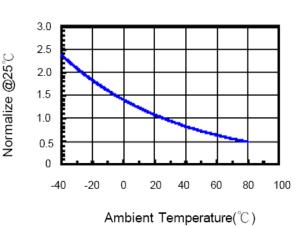
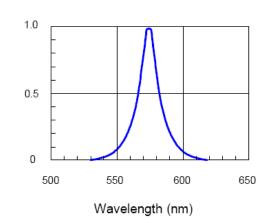
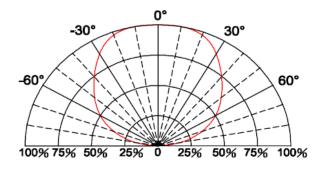


Fig.5 Relative Intensity vs. Wavelength



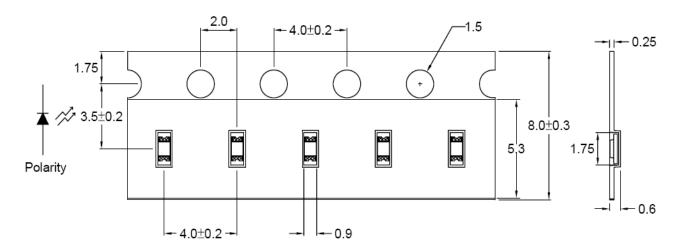
Relative Intensity @20mA

Fig.6 Directive Radiation

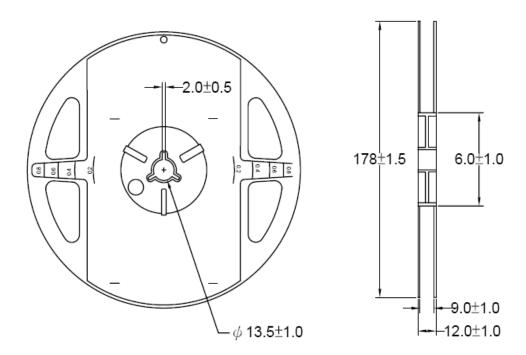


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■ Carrier Type Dimensions



■ Reel Dimensions



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■ Reliability Test Items and Conditions

(1)TEST ITEMS AND RESULTS

Test Item	Standard Test Method	Test Conditions	Note	Number of Damaged
	MIL-ST-202F:107D	-40℃ ~ 105℃	100 cycles	0/60
Thermal Shock	MIL-ST-750D:1051	10min. 10min.		
	MIL-ST-883D:1011		Oyoloo	
	MIL-ST-202F:107D	105℃ ~ 25℃ ~ -55℃ ~ 25℃		
Temperature Cycle	MIL-ST-750D:1051	30min. 5min. 30min. 5min.	10	0/60
	MIL-ST-883D:1010		cycles	0/00
	JIS C 7021:A-4			
Liber Terrane and the Ottoman	MIL-STD-883D:1008	To 105°C 1/ 5°C	1000	0/60
High Temperature Storage	JIS C 7021:B-10	Ta=105°C+/- 5°C	hrs.	0/60
Low Temperature Storage	JIS C 7021:B-12	Ta=-40°C +/-5°C	1000 hrs.	0/60
Steady State Operating Life	MIL-STD-750D:1026			
	MIL-STD-883D:1005	Ta=25℃, I _F =20mA, DC	1000 hrs.	0/60
	JIS C 7021:B-1			
High Temperature &High Humidity	MIL-ST-202F:103B	To 65°C . / 5°C DIL 00 050/	1000	0/60
Storage Test	JIS C 7021:B-11	Ta=65°C+/- 5°C,RH=90-95%,	hrs.	0/60
Solerability Test	MIL-ST-202F:208D	T. Sol:235°C +/- 5°C		
	MIL-STD-750D:2026	Immersion Time 2+/- 0.5sec	10 cycles	0/60
	MIL-STD-883D:2003	Coverage≥95% of the dipped surface		
	IEC 68 Part 2-20		-,	
	JIS C 7021:A-2			
IR Reflow	MIL-STD-750D:2031.2	T=260C Max, 10 sec Max,		
IK Kellow	J-STD-020	Time= 6min		

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■ Cautions

(1) Moisture Proof Package

- A) The moisture proof package, a plastic bag with a zipper, is used to keep moisture to a minimum in the package.
- B) A package of a moisture absorbent material (silica gel) is also inserted into the plastic moisture proof bag and the silica gel changes its color from blue to pink as it absorbs moisture.
- C) The absorbed moisture in the SMT package may vaporize and expand during soldering. This may cause exfoliation of the contacts and damage to the optical characteristics of the LEDs.

(2) Storage Conditions

A) Before opening the package:

The LEDs should be kept at 30° C or less and $45{\sim}60\%$ RH or less and should be used within a year. When storing the LEDs, moisture proof package with absorbent material (silica gel) is recommended.

- B) After opening the package:
 - The LEDs should be kept at 30° C or less and 55% RH or less and should be soldered within 168 hours (7days) after opening the package. The unused LEDs should be stored in moisture proof packages.
- C) It's also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.
- D) If the moisture absorbent material (silica gel) has faded away or the SMD LEDs have exceeded the storage time, baking treatment (more than 24 hours at 65+/-5°C) should be performed before soldering.

(3) Heat Generation

- A) The thermal design of the end product is very important. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- B) The operating current should be decided after considering the ambient maximum temperature of LEDs.

(4) Cleaning

- A) Isopropyl alcohol is recommended to be used as a solvent for cleaning the LEDs.
- B) Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

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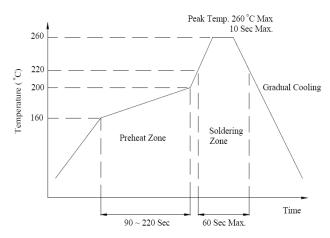
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(5) Soldering

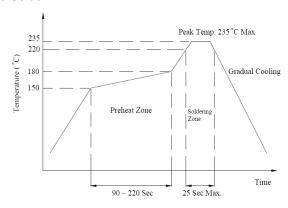
Reflow Soldering (recommended):

- A) To prevent from cracking, please bake (65° C, 24hrs)before soldering.
- B) When soldering, do not load stress on the LEDs during heating.
- C) Never take next process until the component is cooled down to room temperature after reflow.
- D) After soldering, do not warp the circuit board.
- E) The recommended reflow soldering profile (measuring on the surface of the LED resin) is the following:

(a) Lead-Free Solder



(b) Lead Solder



Manual Soldering (not recommended):

- A) To prevent from cracking, please bake (65°C, 24hrs) before soldering.
- B) Temperature at tip of iron: 250°C Max. (25W).
- C) It's banned to load any stress on the resin during soldering.
- D) Soldering time: 3 sec. Max.(one time only).

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- (6) ESD (eletrostatic discharge) protection (base on machine mode)
 - A) The product is Gallium Nitride (GaN) based light emitting diode (LED) and is extremely sensitive to ESD. Users are strongly recommended to take necessary meter to test the static electricty and avoid ESD when handling this product.
 - B) Proper grounding of machines (via $1M\Omega$), using static disspative mats, containers, working uniforms and shoes are considered to be effective against ESD.
 - C) An ionizer is recommended in the facility or environment where ESD may be generated easily, and soldering iron with a grounded tip is also recommended.
 - D) When inspecting the final products in which LEDs are assembled, it is recommended to check whether the assembled LEDs are damaged by ESD or not. It is simple to find damaged LEDs by light-on or VF test at lower current (below 1mA is recommended).
 - E) ESD damaged LEDs will show some unusual characteristics such as the remarkable increasing of leak current, the decreasing of forward voltage, or the LEDs do not light on at the low current.

(7) Other

- A) Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- B) The LED light output is strong enough to injure human eyes. Precaution must be taken to prevent looking directly at the LEDs with unaided eyes for more than a few seconds.
- C) The LEDs described here are intended to be used for ordinary electronic equipment, please consult Unilite Opto in advance for information on applications.
- D) Installing a protection device in the LED driving circuit to avoid surge current exceeding the max rating during on/off switching.
- E) The appearance and specifications of the product may be modified for improvement without notice.
- F) Please use the product within 168 hours after opening the seal and keep under 30 $^{\circ}$ C and 70% humidity.
- G) Unilite Opto Technology will not be responsible for any claim for damage if the user use the product without following the caution or instruction of the specification.